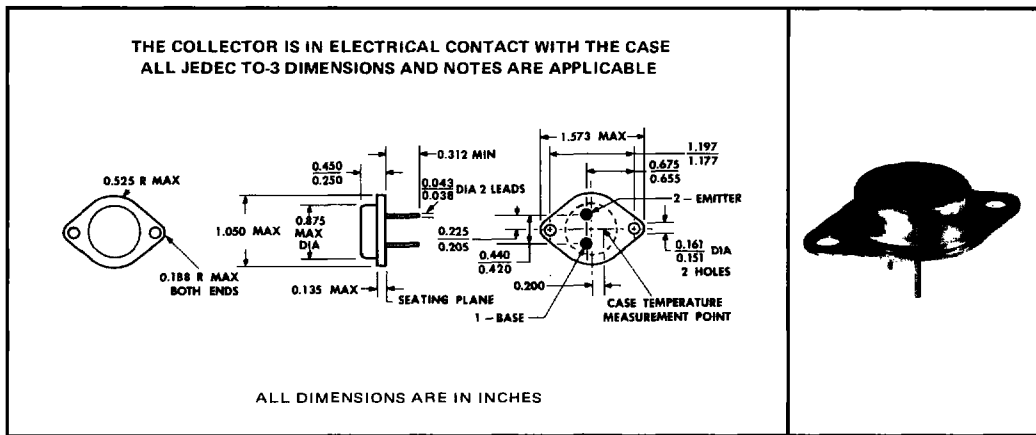


# TYPES 2N6326, 2N6327, 2N6328 N-P-N SINGLE-DIFFUSED MESA SILICON POWER TRANSISTORS

FOR POWER-AMPLIFIER AND HIGH-SPEED-SWITCHING APPLICATIONS  
DESIGNED FOR COMPLEMENTARY USE WITH 2N6329, 2N6330, 2N6331

- 200 W at 25°C Case Temperature
- 30-A Rated Collector Current
- 200-mJ Reverse Energy Rating
- High SOA Capability, 20 V and 10 A

\*mechanical data



\*absolute maximum ratings at 25°C case temperature (unless otherwise noted)

	2N6326	2N6327	2N6328
Collector-Base Voltage	60 V	80 V	100 V
Collector-Emitter Voltage (See Note 1)	60 V	80 V	100 V
Emitter-Base Voltage	5 V	5 V	5 V
Continuous Collector Current	← 30 A →		
Peak Collector Current (See Note 2)	← 40 A →		
Continuous Base Current	← 10 A →		
Safe Operating Areas at (or below) 25°C Case Temperature	← See Figures 3 and 4 →		
Continuous Device Dissipation at (or below) 25°C Case Temperature (See Note 3)	← 200 W →		
Continuous Device Dissipation at 100°C Case Temperature (See Note 3)	← 114 W →		
Continuous Device Dissipation at (or below) 25°C Free-Air Temperature (See Note 4)	← 5 W →		
Unclamped Inductive Load Energy (See Note 5)	← 200 mJ →		
Operating Collector Junction Temperature Range	← -65°C to 200°C →		
Storage Temperature Range	← -65°C to 200°C →		
Terminal Temperature 1/8 Inch from Case for 10 Seconds	← 250°C →		

- NOTES: 1. These values apply when the base-emitter diode is open-circuited.  
2. This value applies for  $t_w \leq 1$  ms, duty cycle  $\leq 10\%$ .  
3. Derate linearly to 200°C case temperature at the rate of 1.14 W/°C or refer to Dissipation Derating Curve, Figure 5.  
4. Derate linearly to 200°C free-air temperature at the rate of 28.6 mW/°C or refer to Dissipation Derating Curve, Figure 6.  
5. This rating is based on the capability of the transistors to operate safely in the circuit of Figure 2.  $L = 20$  mH,  $R_{BB2} = 100 \Omega$ ,  $V_{BB2} = 0$  V,  $R_S = 0.1 \Omega$ ,  $V_{CC} = 20$  V. Energy  $\approx I_C^2 L/2$ .

\*JEDEC registered data. This data sheet contains all applicable registered data in effect at the time of publication.

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# TYPES 2N6326, 2N6327, 2N6328

## N-P-N SINGLE-DIFFUSED MESA SILICON POWER TRANSISTORS

\*electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	2N6326	2N6327	2N6328	UNIT
		MIN MAX	MIN MAX	MIN MAX	
$V_{(BR)CEO}$ Collector-Emitter Breakdown Voltage	$I_C = 30 \text{ mA}$ , $I_B = 0$ , See Note 6	60	80	100	V
$I_{CEO}$ Collector Cutoff Current	$V_{CE} = 30 \text{ V}$ , $I_B = 0$	1			mA
	$V_{CE} = 40 \text{ V}$ , $I_B = 0$		1		
	$V_{CE} = 50 \text{ V}$ , $I_B = 0$			1	
$I_{CES}$ Collector Cutoff Current	$V_{CE} = 60 \text{ V}$ , $V_{BE} = 0$	0.5			mA
	$V_{CE} = 80 \text{ V}$ , $V_{BE} = 0$		0.5		
	$V_{CE} = 100 \text{ V}$ , $V_{BE} = 0$			0.5	
	$V_{CE} = 30 \text{ V}$ , $V_{BE} = 0$ , $T_C = 150^\circ\text{C}$	5			
	$V_{CE} = 40 \text{ V}$ , $V_{BE} = 0$ , $T_C = 150^\circ\text{C}$		5		
	$V_{CE} = 50 \text{ V}$ , $V_{BE} = 0$ , $T_C = 150^\circ\text{C}$			5	
$I_{EBO}$ Emitter Cutoff Current	$V_{EB} = 5 \text{ V}$ , $I_C = 0$	0.5	0.5	0.5	mA
$h_{FE}$ Static Forward Current Transfer Ratio	$V_{CE} = 4 \text{ V}$ , $I_C = 5 \text{ A}$	25	25	25	
	$V_{CE} = 4 \text{ V}$ , $I_C = 15 \text{ A}$	12	12	12	
	$V_{CE} = 4 \text{ V}$ , $I_C = 30 \text{ A}$	6 30	6 30	6 30	
$V_{BE}$ Base-Emitter Voltage	$V_{CE} = 4 \text{ V}$ , $I_C = 15 \text{ A}$	2	2	2	V
	$V_{CE} = 4 \text{ V}$ , $I_C = 30 \text{ A}$	4	4	4	
$V_{CE(sat)}$ Collector-Emitter Voltage	$I_B = 2 \text{ A}$ , $I_C = 15 \text{ A}$	1.5	1.5	1.5	V
	$I_B = 7.5 \text{ A}$ , $I_C = 30 \text{ A}$	3	3	3	
$h_{fe}$ Small-Signal Common-Emitter Forward Current Transfer Ratio	$V_{CE} = 10 \text{ V}$ , $I_C = 1 \text{ A}$ , $f = 1 \text{ kHz}$	30	30	30	
$ h_{fe} $ Small-Signal Common-Emitter Forward Current Transfer Ratio	$V_{CE} = 10 \text{ V}$ , $I_C = 1 \text{ A}$ , $f = 1 \text{ MHz}$	3	3	3	

NOTES: 6. These parameters must be measured using pulse techniques.  $t_w = 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .

7. These parameters are measured with voltage-sensing contacts separate from the current-carrying contacts and located within 0.125 inch from the device body.

\*JEDEC registered data

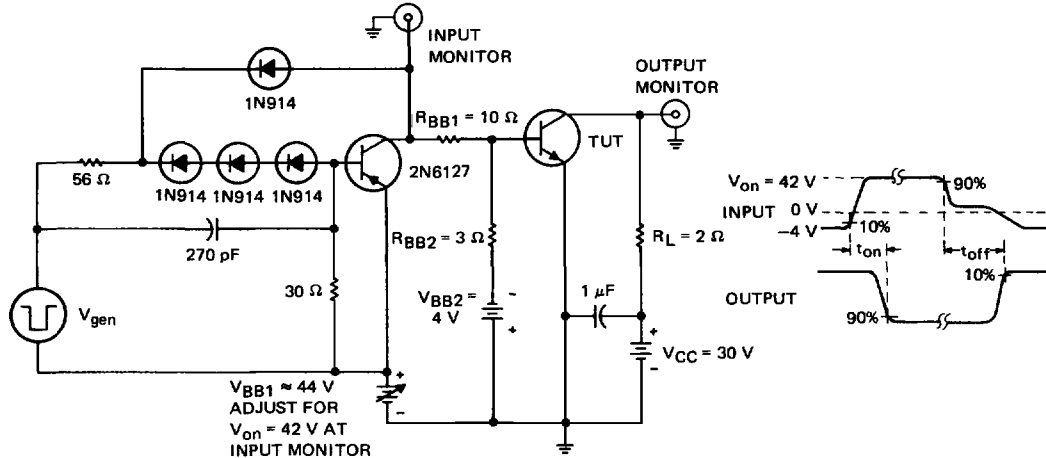
### switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS†	TYP	UNIT
$t_{on}$ Turn-On Time	$I_C = 15 \text{ A}$ , $I_B(1) = 2 \text{ A}$ , $I_B(2) = -2 \text{ A}$	0.6	$\mu\text{s}$
$t_{off}$ Turn-Off Time	$V_{BE(off)} = -4 \text{ V}$ , $R_L = 2 \Omega$ , See Figure 1	0.9	

†Voltage and current values shown are nominal, exact values vary slightly with transistor parameters.

# TYPES 2N6326, 2N6327, 2N6328 N-P-N SINGLE-DIFFUSED MESA SILICON POWER TRANSISTORS

## PARAMETER MEASUREMENT INFORMATION



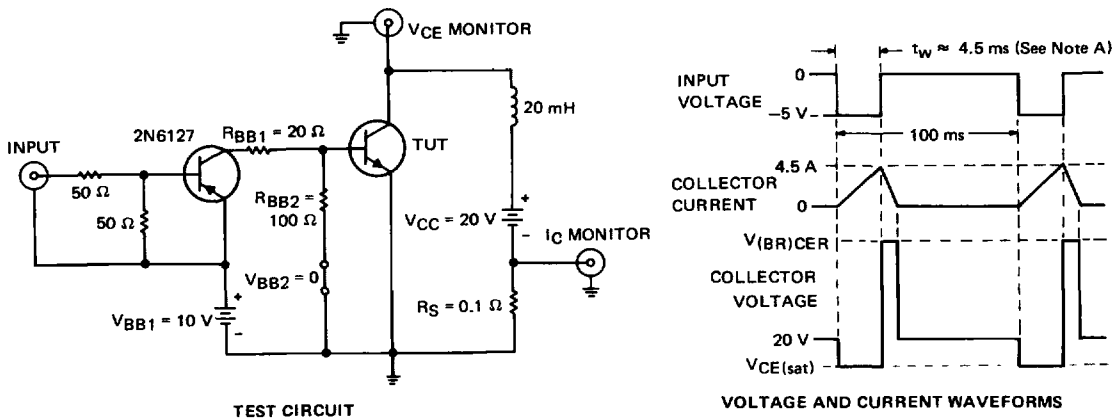
**TEST CIRCUIT**

**VOLTAGE WAVEFORMS**

- NOTES:
- A.  $V_{gen}$  is a  $-30\text{-V}$  pulse (from  $0\text{ V}$ ) into a  $50\text{-}\Omega$  termination.
  - B. The  $V_{gen}$  waveform is supplied by a generator with the following characteristics:  $t_r \leq 15\text{ ns}$ ,  $t_f \leq 15\text{ ns}$ ,  $Z_{out} = 50\text{ }\Omega$ ,  $t_w = 20\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .
  - C. Waveforms are monitored on an oscilloscope with the following characteristics:  $t_r \leq 15\text{ ns}$ ,  $R_{in} > 10\text{ M}\Omega$ ,  $C_{in} \leq 11.5\text{ pF}$ .
  - D. Resistors must be noninductive types.
  - E. The d-c power supplies may require additional bypassing in order to minimize ringing.

FIGURE 1

## INDUCTIVE LOAD SWITCHING



**TEST CIRCUIT**

**VOLTAGE AND CURRENT WAVEFORMS**

- NOTE A: Input pulse width is increased until  $I_{CM} = 4.5\text{ A}$ .

FIGURE 2

# TYPES 2N6326, 2N6327, 2N6328 N-P-N SINGLE-DIFFUSED MESA SILICON POWER TRANSISTORS

## MAXIMUM SAFE OPERATING AREAS

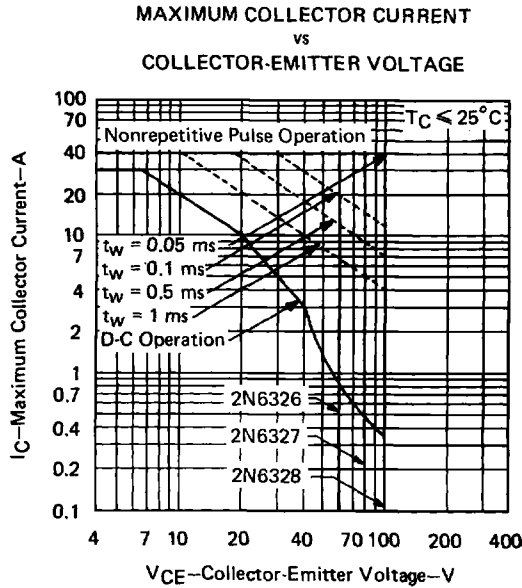


FIGURE 3

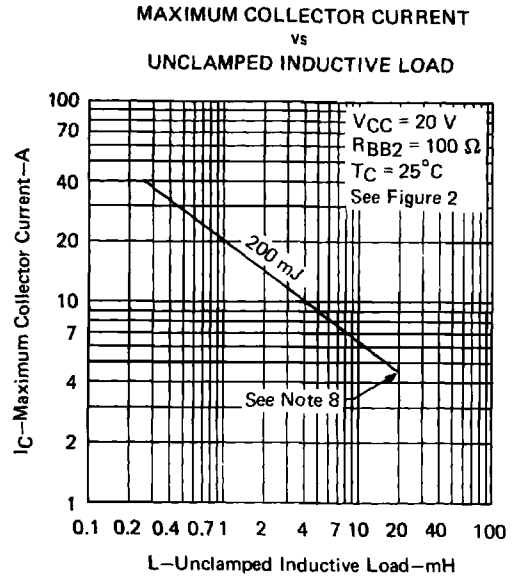


FIGURE 4

NOTE B: Above this point the safe operating area has not been defined.

## THERMAL INFORMATION

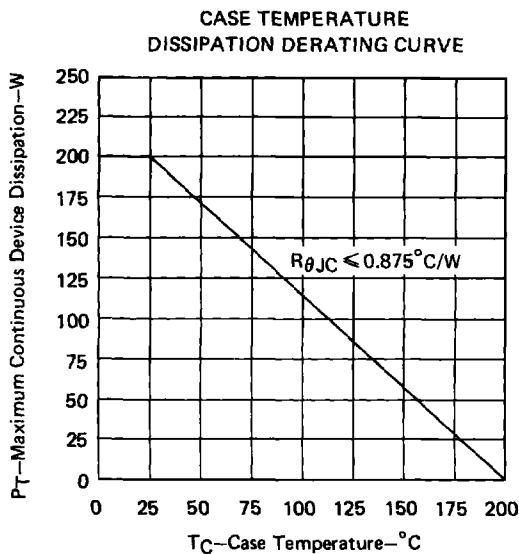


FIGURE 5

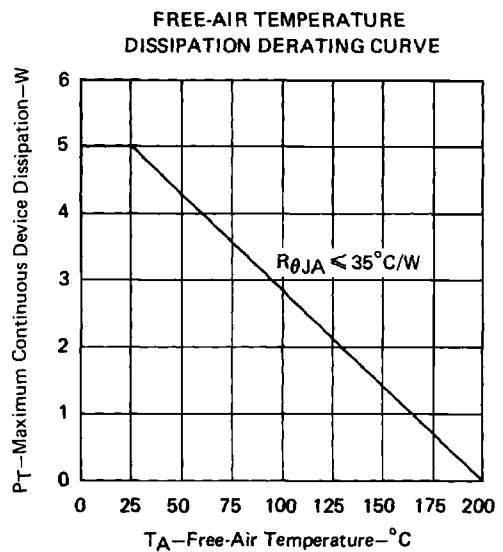


FIGURE 6